N-Channel Trench Power MOSFET

General Description

The CS48N18 is N-channel MOS Field Effect Transistor designed for high current switching applications. Rugged E_{AS} capability and ultra low $R_{DS(ON)}$ is suitable for PWM, load switching especially for E-Bike controller applications.

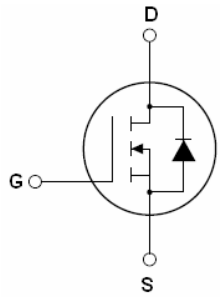
Features

- V_{DS}=70V； I_D=158A@ V_{GS}=10V；
  $R_{DS(ON)}$<4.0mΩ @ V_{GS}=10V
- Special Designed for E-Bike Controller Application
- Ultra Low On-Resistance
- High UIS and UIS 100% Test

Application

- 48V E-Bike Controller Applications
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply

To-220 Top View



Schematic Diagram

V_{DSS} = 70V

I_{DSS} = 158A

$R_{DS(ON)}$ = 3.3mΩ

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
CS48N18	48N18	TO-220	-	-	-

Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
V_{DS}	Drain-Source Voltage (V_{GS}=0V)	70	V
V_{GS}	Gate-Source Voltage (V_{DS}=0V)	±25	V
$I_{D\ (DC)}$	Drain Current (DC) at Tc=25℃	158	A
$I_{D\ (DC)}$	Drain Current (DC) at Tc=100℃	110	A
$I_{DM\ (pluse)}$	Drain Current-Continuous@ Current-Pulsed **(Note 1)**	632	A
dv/dt	Peak Diode Recovery Voltage	7.5	V/ns
P_D	Maximum Power Dissipation(Tc=25℃)	230	W
	Derating Factor	1.54	W/℃
E_{AS}	Single Pulse Avalanche Energy **(Note 2)**	1300	mJ
T_J,T_{STG}	Operating Junction and Storage Temperature Range	-55 To 175	℃

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2.E_{AS} condition:T_J=25℃,V_{DD}=33V,V_G=10V

Table 2. Thermal Characteristic

Symbol	Parameter	Value	Max	Unit
$R_{\theta JC}$	Thermal Resistance,Junction-to-Case	---	0.65	℃/W

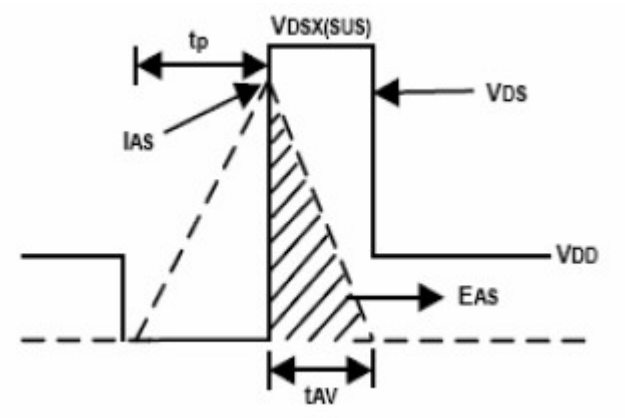
Table 3. Electrical Characteristics (TA=25℃unless otherwise noted)

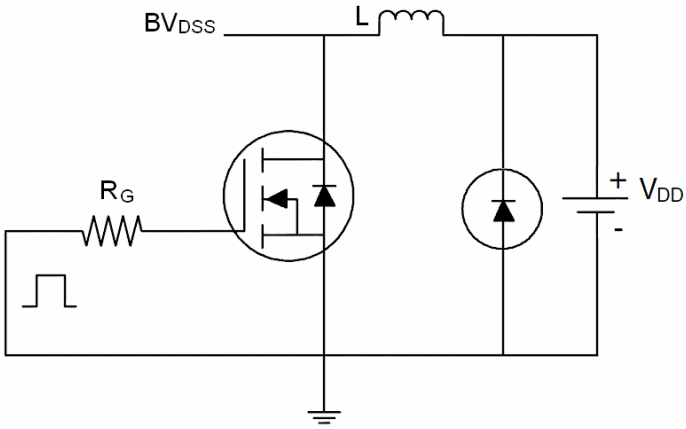
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V I_D=250μA	70			V
I_{DSS}	Zero Gate Voltage Drain Current(Tc=25℃)	V_{DS}=68V,V_{GS}=0V			1	μA
I_{DSS}	Zero Gate Voltage Drain Current(Tc=125℃)	V_{DS}=68V,V_{GS}=0V			1	μA
I_{GSS}	Gate-Body Leakage Current	V_{GS}=±25V,V_{DS}=0V			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS},I_D=250μA	2		4	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	V_{GS}=10V, I_D=40A		3.3	4.0	mΩ
Dynamic Characteristics						
g_{FS}	Forward Transconductance	V_{DS}=10V,I_D=40A	22			S
C_{iss}	Input Capacitance	V_{DS}=25V,V_{GS}=0V, f=1.0MHz		5489		pF
C_{oss}	Output Capacitance			710		pF
C_{rss}	Reverse Transfer Capacitance			206		pF
Q_g	Total Gate Charge	V_{DS}=30V,I_D=30A, V_{GS}=10V		186		nC
Q_{gs}	Gate-Source Charge			37		nC
Q_{gd}	Gate-Drain Charge			97		nC
Switching Times						
$t_{d(on)}$	Turn-on Delay Time	V_{DD}=30V,I_D=2A,R_L=15Ω V_{GS}=10V,R_G=2.5Ω		30		nS
t_r	Turn-on Rise Time			37		nS
$t_{d(off)}$	Turn-Off Delay Time			78		nS
t_f	Turn-Off Fall Time			36		nS
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current(Body Diode)			158		A
I_{SDM}	Pulsed Source-Drain Current(Body Diode)			632		A
V_{SD}	Forward on Voltage **(Note 1)**	T_J=25℃,I_{SD}=40A,V_{GS}=0V		0.82	0.99	V
t_{rr}	Reverse Recovery Time **(Note 1)**	T_J=25℃,I_F=75A di/dt=100A/μs		33		nS
Q_{rr}	Reverse Recovery Charge **(Note 1)**			45		nC
t_{on}	Forward Turn-on Time	Intrinsic turn-on time is negligible(turn-on is dominated by L_S+L_D)				

Notes 1.Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 1.5%, R_G=25Ω, Starting T_J=25℃

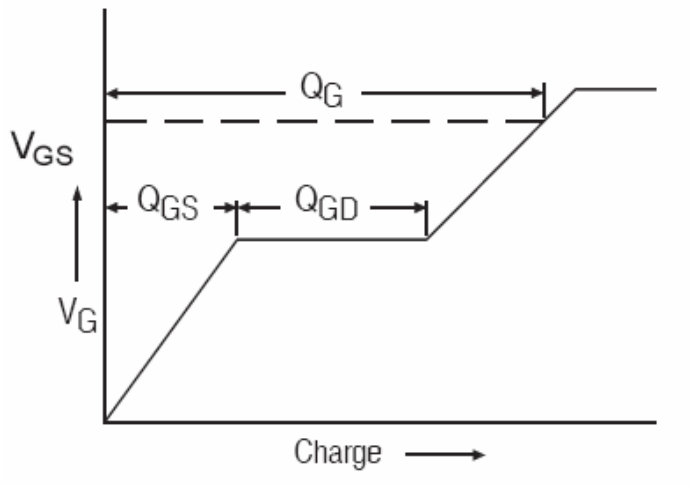
Test Circuit

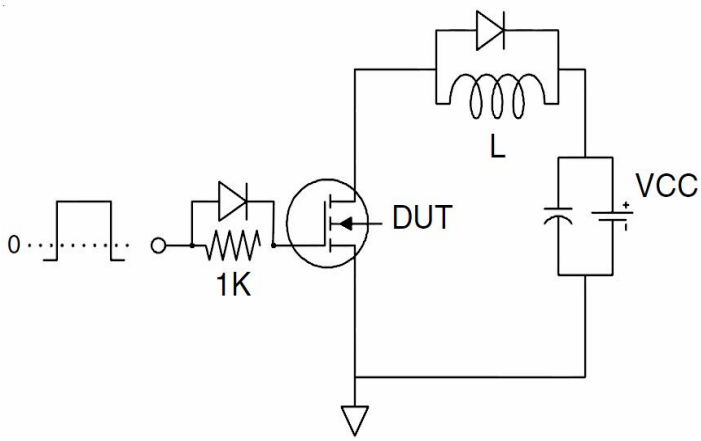
1）E_{AS} Test Circuits



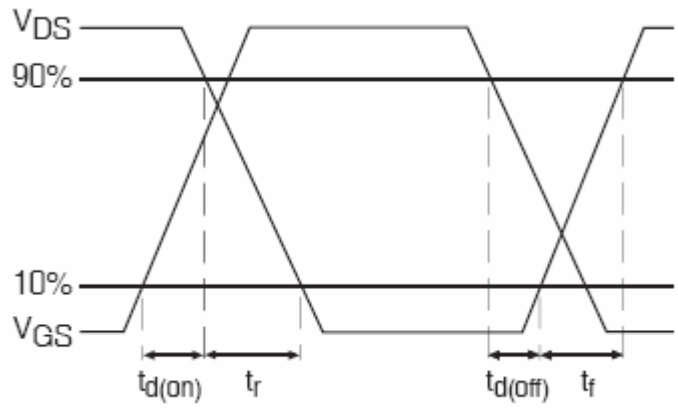


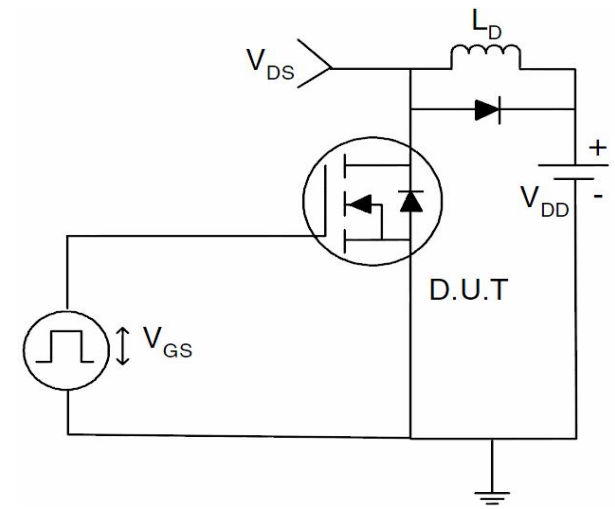
2）Gate charge Test Circuit:





3）Switch Time Test Circuit:





TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)

Figure1. Output Characteristics

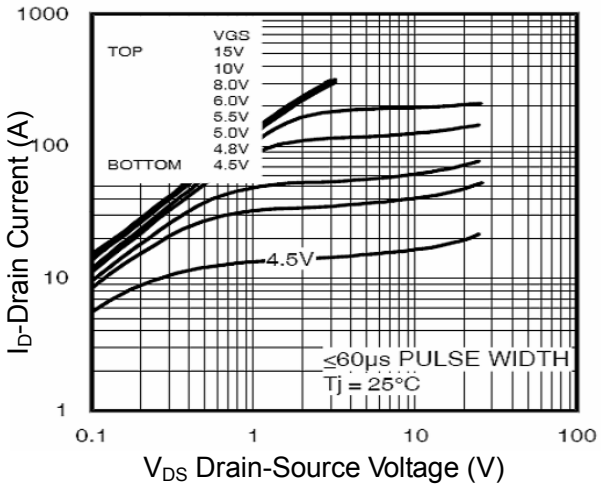


Figure2. Transfer Characteristics

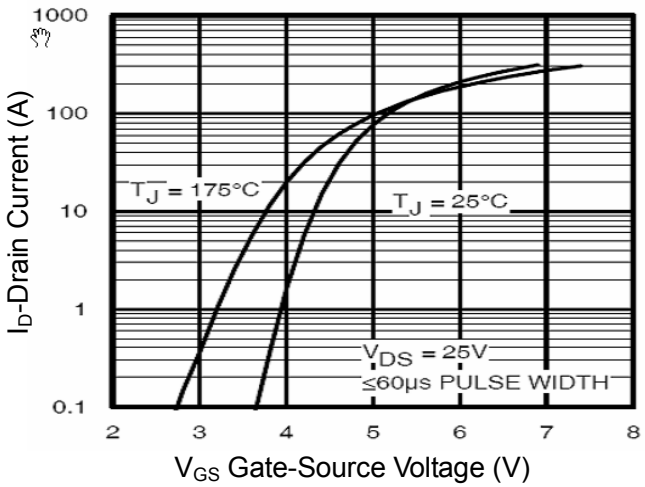


Figure3. ID vs Junction Temperature

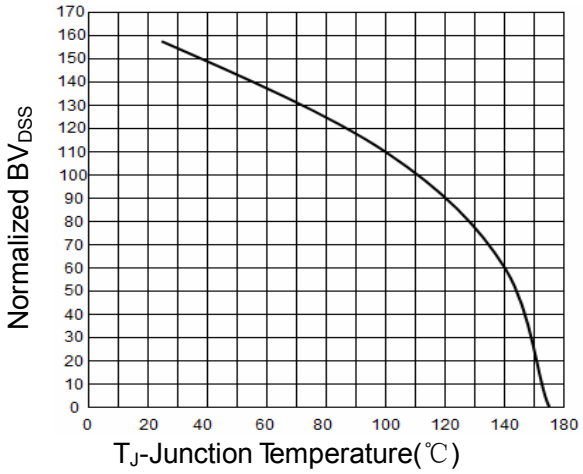


Figure4. $R_{DS(ON)}$ vs Junction Temperature

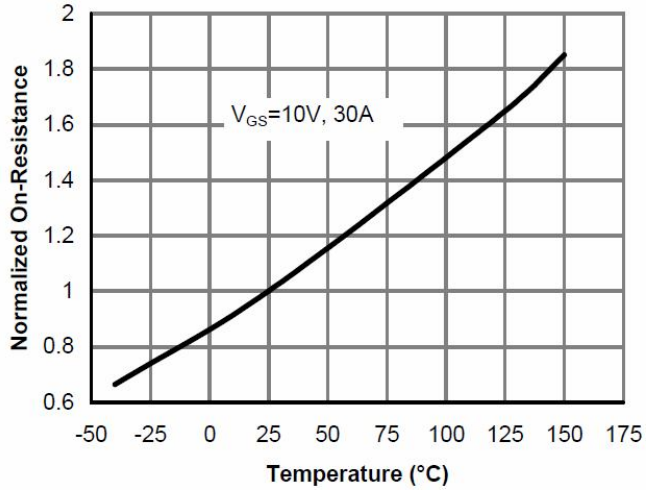


Figure5. BV_{DSS} vs Junction Temperature

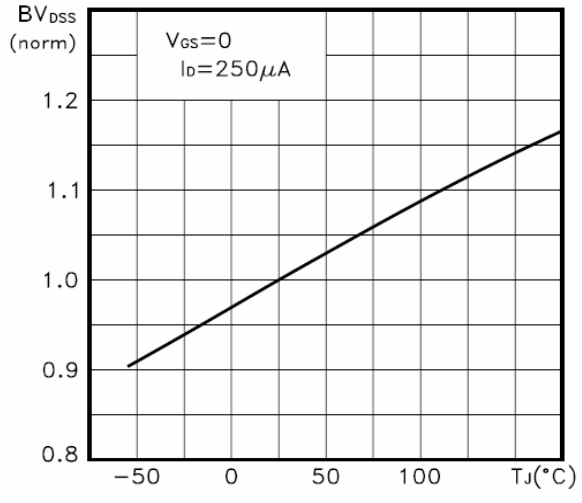


Figure6. $V_{GS(th)}$ vs Junction Temperature

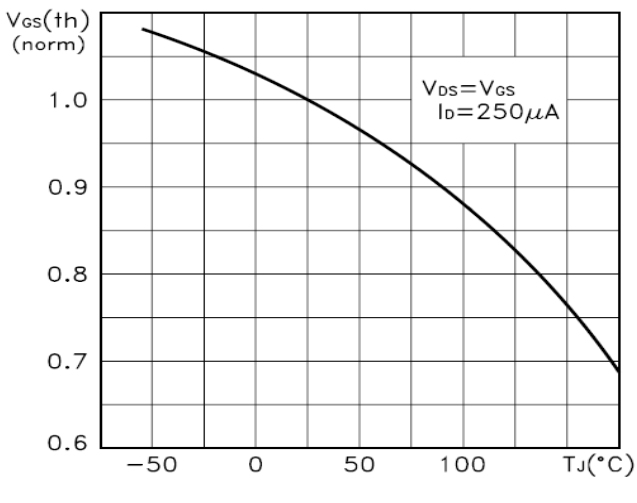


Figure7. Gate Charge

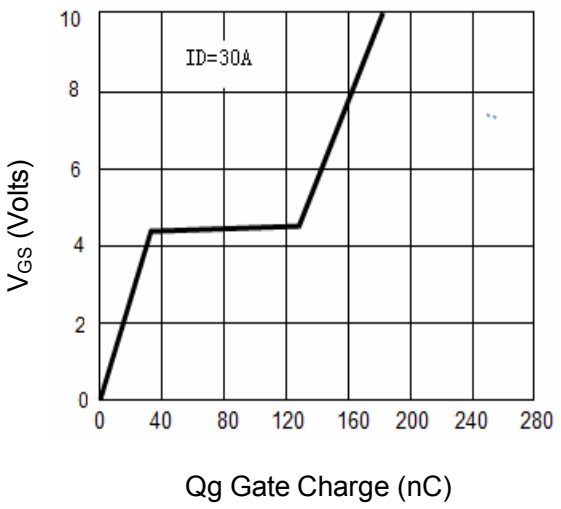


Figure8. Capacitance vs Vds

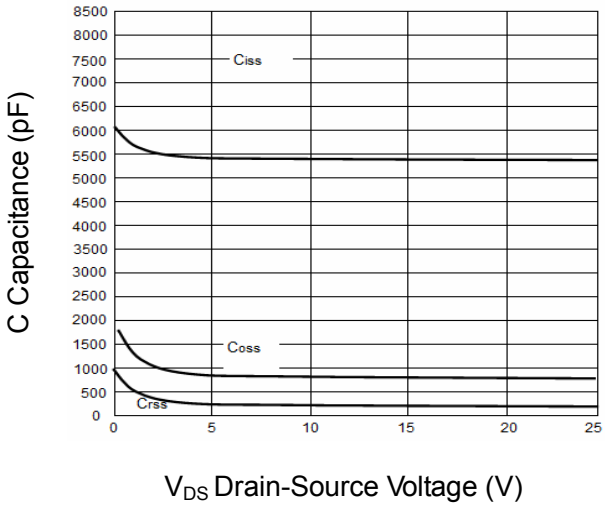


Figure9. Source- Drain Diode Forward

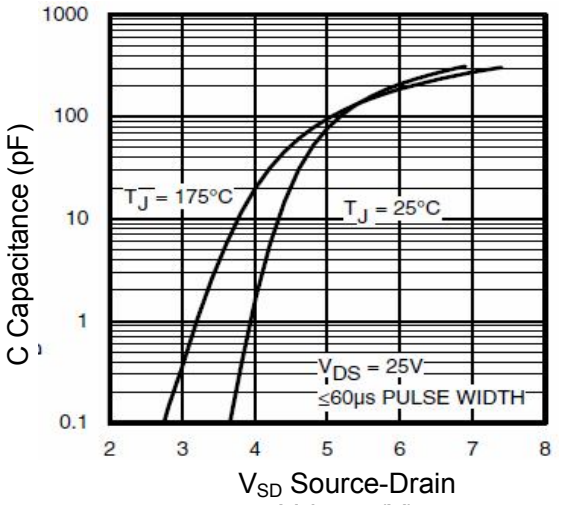


Figure10. Safe Operation Area

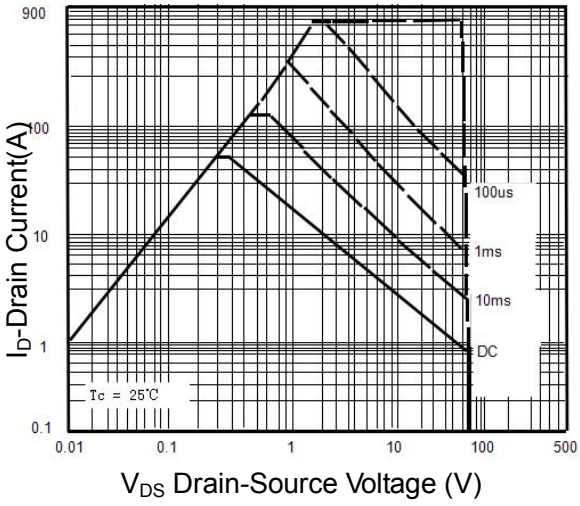
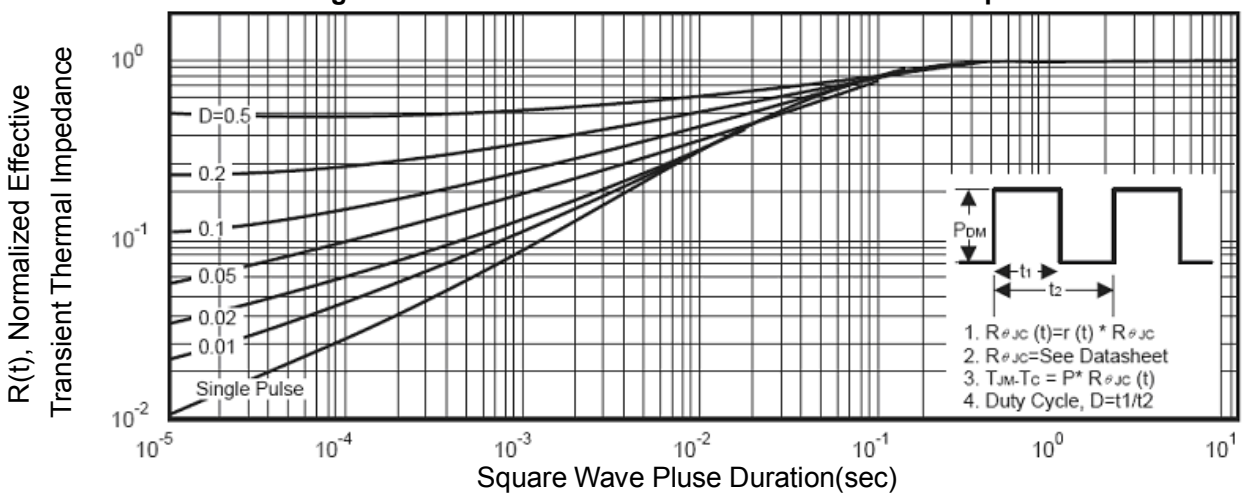
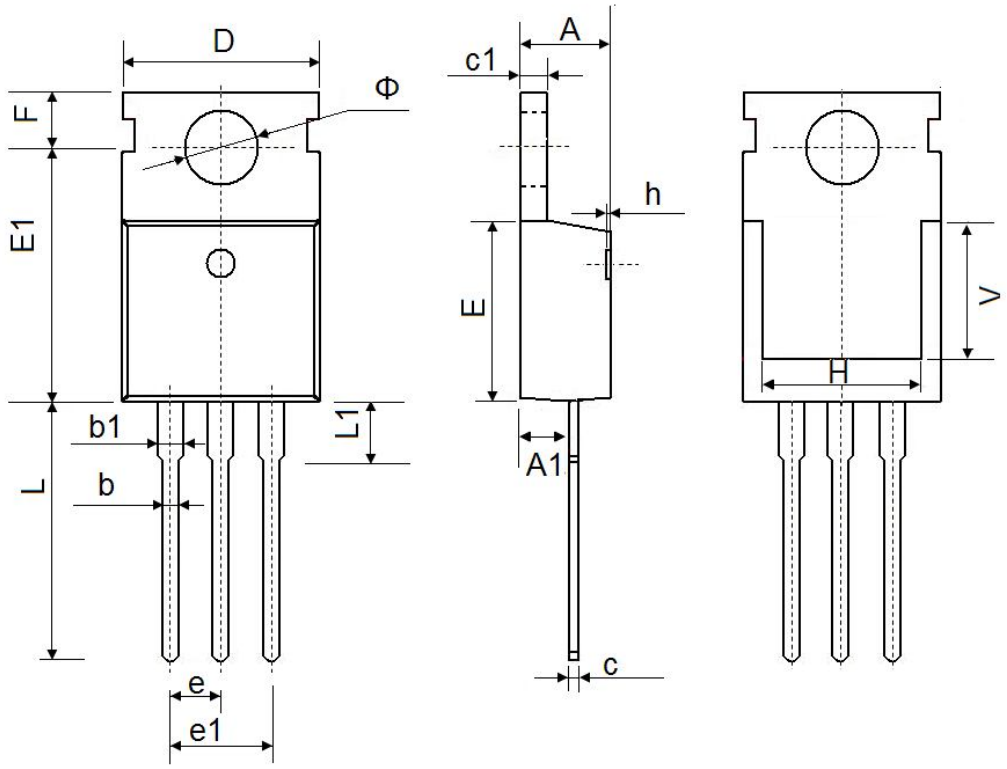


Figure11. Normalized Maximum Transient Thermal Impedance



TO-220 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max
A	4.300	4.700	0.169	0.185
A1	2.200	2.600	0.087	0.102
b	0.700	0.950	0.028	0.037
b1	1.170	1.410	0.046	0.056
c	0.450	0.650	0.018	0.026
c1	1.200	1.400	0.047	0.055
D	9.600	10.400	0.378	0.409
E	8.8500	9.750	0.348	0.384
E1	12.650	12.950	0.498	0.510
e	2.540 TYP.		0.100TYP.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.750	14.300	0.502	0.563
L1	2.850	3.950	0.112	0.156
V	7.500 REF.		0.295 REF.	
Φ	3.400	4.000	0.134	0.157